

< Silicon RF Power MOS FET (Discrete) >

# RD07MVS1

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 520MHz, 7W

## DESCRIPTION

RD07MVS1 is a MOS FET type transistor specifically designed for VHF/UHF RF power amplifiers applications.

## FEATURES

High power gain:

$P_{out} > 7W$ ,  $G_p > 10dB @ V_{dd} = 7.2V, f = 520MHz$

High Efficiency: 60%typ. (175MHz)

High Efficiency: 55%typ. (520MHz)

## APPLICATION

For output stage of high power amplifiers in VHF/UHF band mobile radio sets.

## RoHS COMPLIANT

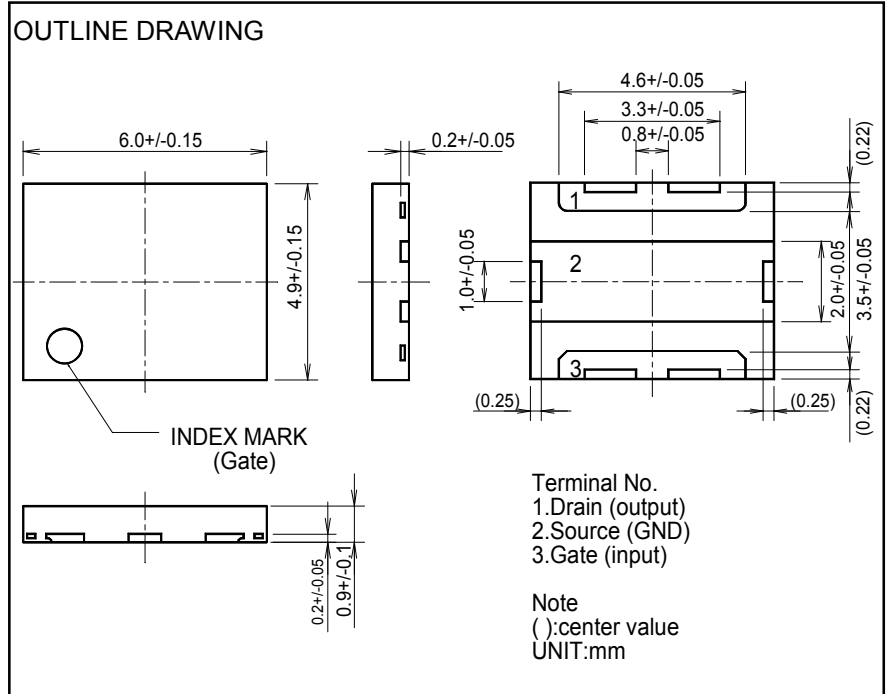
RD07MVS1-101, T112 is a RoHS compliant product.

RoHS compliance is indicating by the letter "G" after the Lot Marking.

This product includes the lead in high melting temperature type solders.

However, it is applicable to the following exceptions of RoHS Directions.

1. Lead in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85% lead.)



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**ABSOLUTE MAXIMUM RATINGS**

(Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	Vgs=0V	30	V
VGSS	Gate to source voltage	Vds=0V	+/- 20	V
Pch	Channel dissipation	Tc=25°C	50	W
Pin	Input Power	Zg=Zl=50Ω	1.5	W
ID	Drain Current	-	3	A
Tch	Junction Temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +125	°C
Rth j-c	Thermal resistance	Junction to case	2.5	°C/W

Note: Above parameters are guaranteed independently.

**ELECTRICAL CHARACTERISTICS** (Tc=25°C, UNLESS OTHERWISE NOTED)

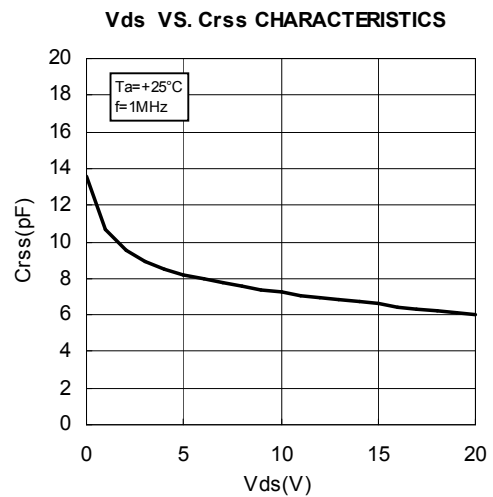
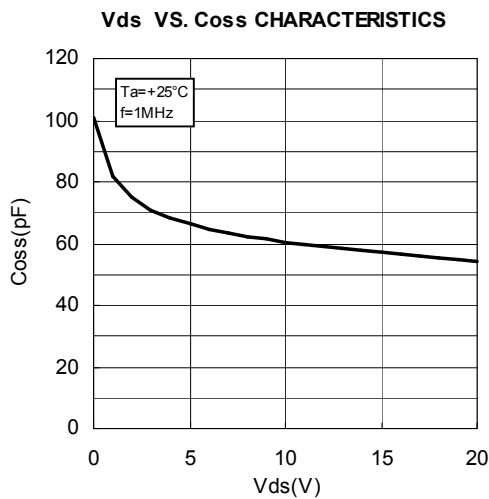
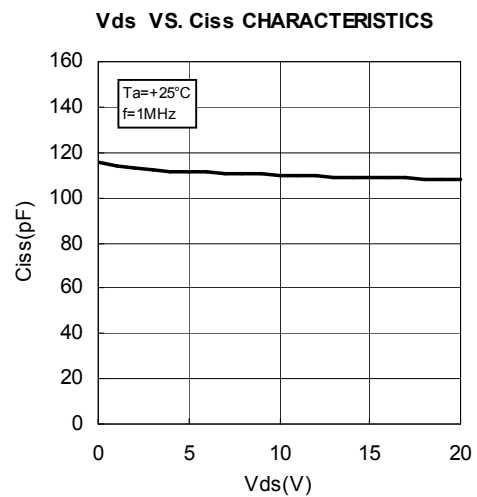
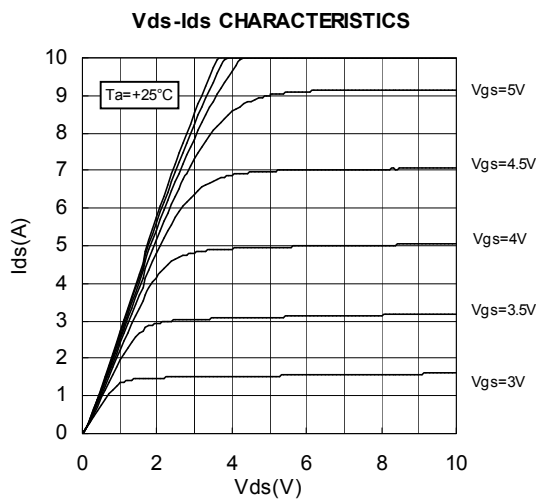
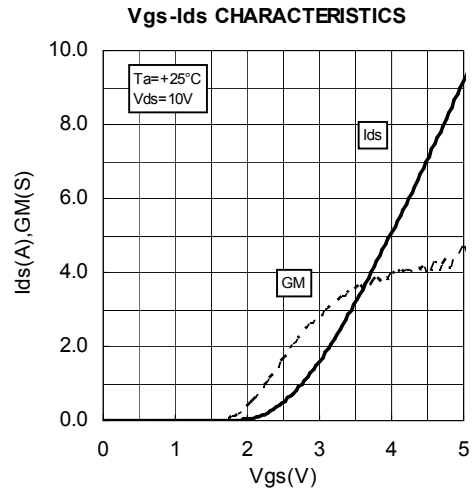
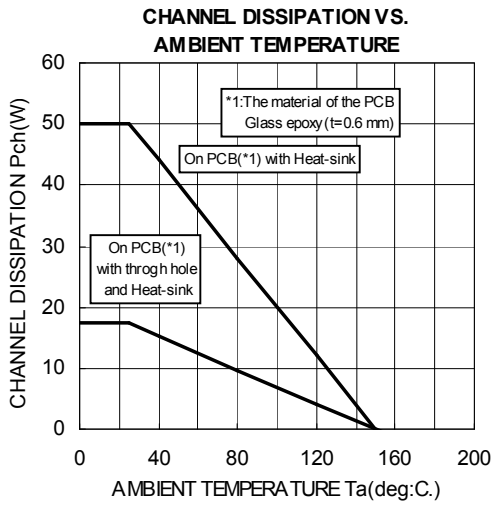
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX.	
IDSS	Zero gate voltage drain current	Vds=17V, Vgs=0V	-	-	200	uA
IGSS	Gate to source leak current	Vgs=10V, Vds=0V	-	-	1	uA
VTH	Gate threshold Voltage	Vds=12V, Ids=1mA	1.4	1.7	2.4	V
Pout1	Output power	f=175MHz, VDD=7.2V	7	8	-	W
ηD1	Drain efficiency	Pin=0.3W, Idq=700mA	55	60	-	%
Pout2	Output power	f=520MHz, VDD=7.2V	7	8	-	W
ηD2	Drain efficiency	Pin=0.7W, Idq=750mA	50	55	-	%
	Load VSWR tolerance	VDD=9.2V, Po=7W(Pin Control) f=175MHz, Idq=700mA, Zg=50Ω Load VSWR=20:1(All Phase)	No destroy			-
	Load VSWR tolerance	VDD=9.2V, Po=7W(Pin Control) f=520MHz, Idq=750mA, Zg=50Ω Load VSWR=20:1(All Phase)	No destroy			-

Note: Above parameters, ratings, limits and conditions are subject to change.

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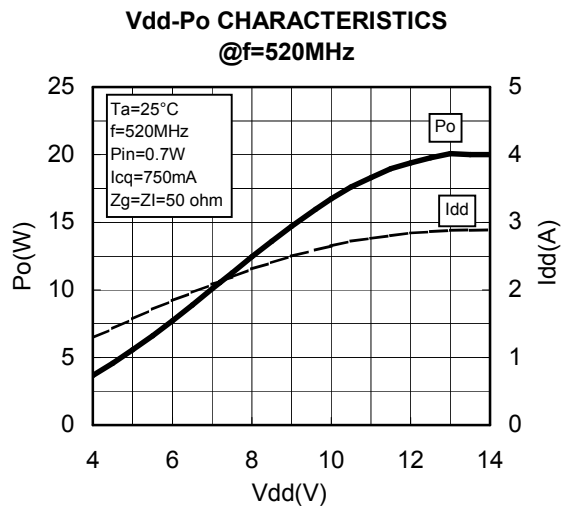
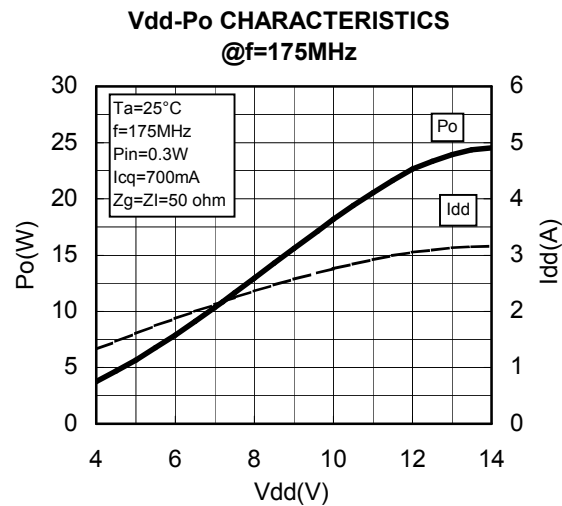
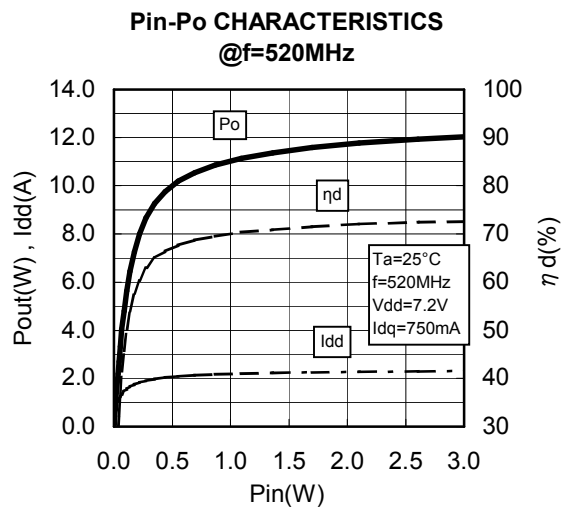
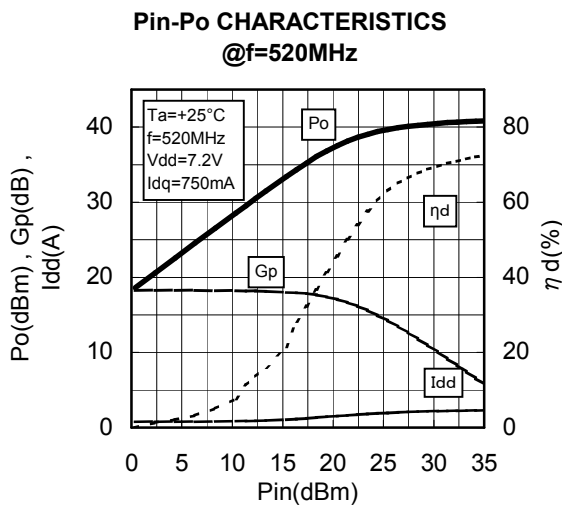
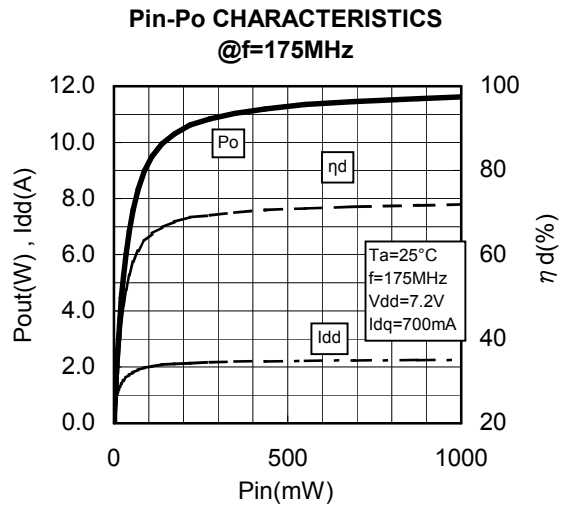
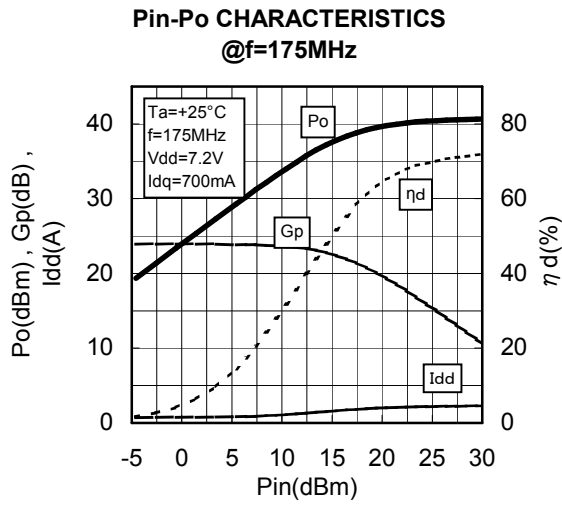
## TYPICAL CHARACTERISTICS



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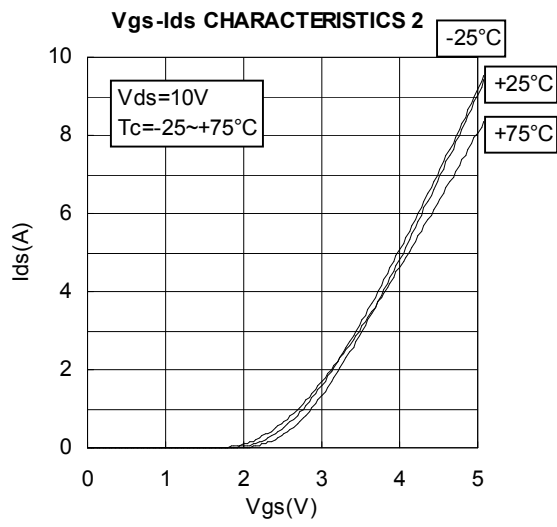
## TYPICAL CHARACTERISTICS



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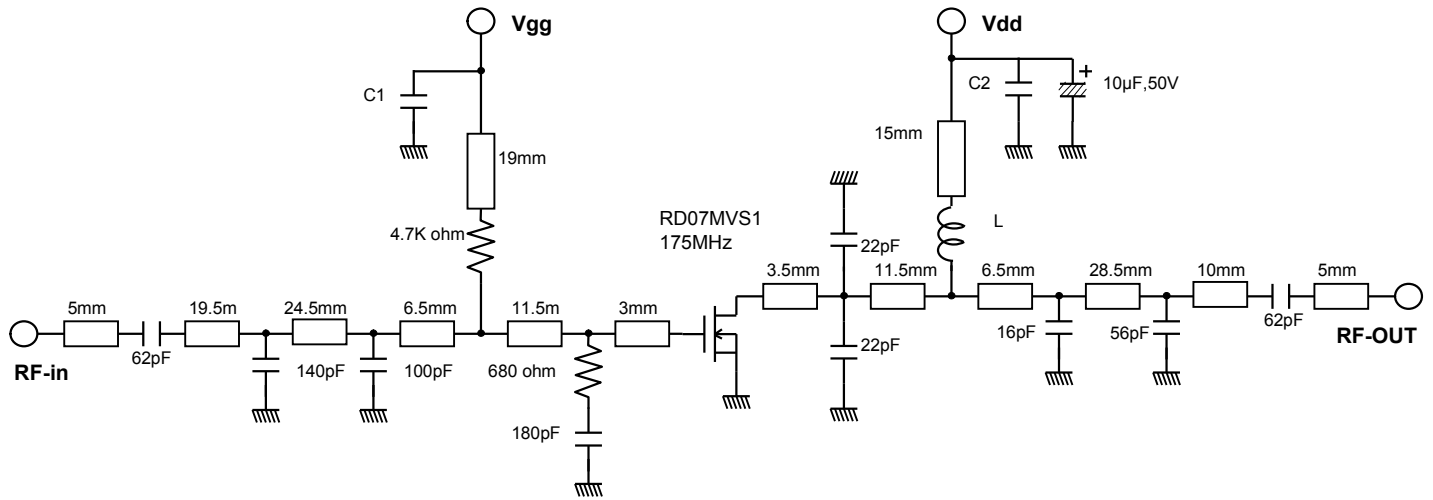
## TYPICAL CHARACTERISTICS



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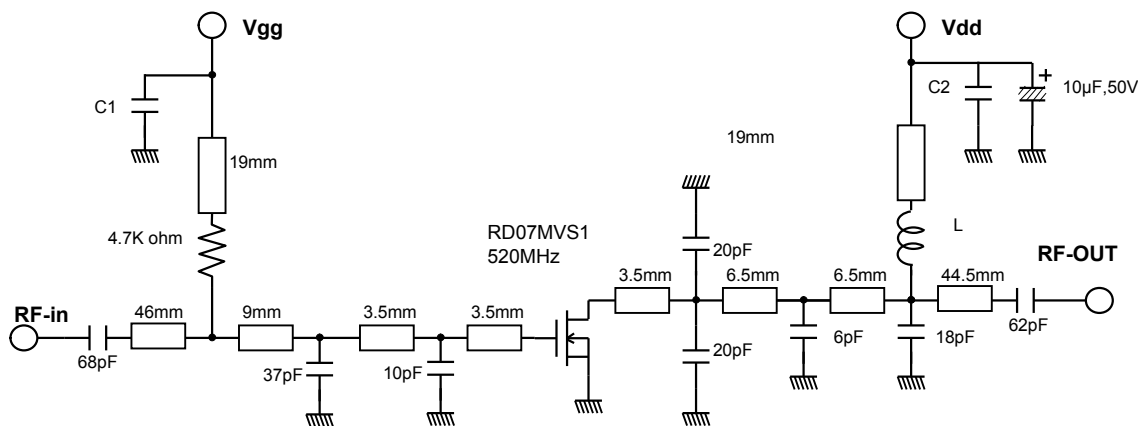
## TEST CIRCUIT(f=175MHz)



L: Enameled wire 7 Turns, D: 0.43mm, 2.46mm O.D  
 C1, C2: 1000pF, 0.0022µF in parallel

Note: Board material PTFE substrate  
 Micro strip line width=2.2mm/50 ohm, er:2.7, t=0.8mm  
 W: line width=1.0mm

## TEST CIRCUIT(f=520MHz)



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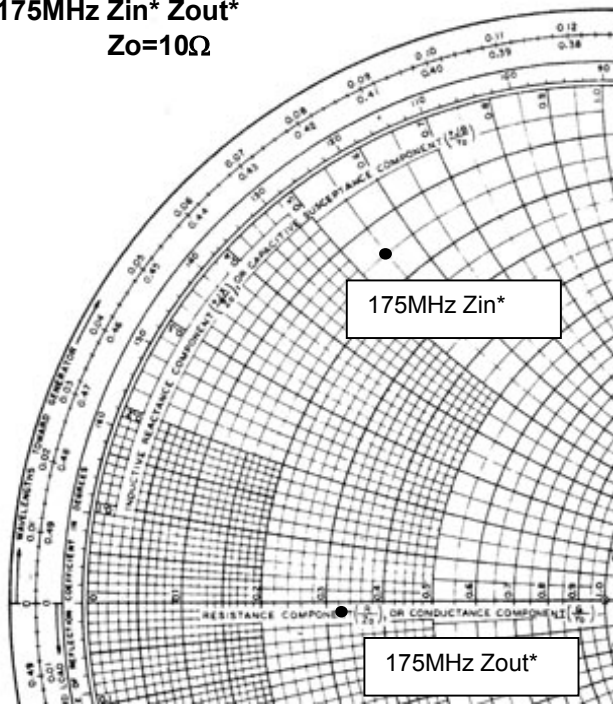
Note: Board material PTFE substrate  
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## INPUT/OUTPUT IMPEDANCE VS. FREQUENCY CHARACTERISTICS

175MHz  $Z_{in}^*$   $Z_{out}^*$   
 $Z_o=10\Omega$

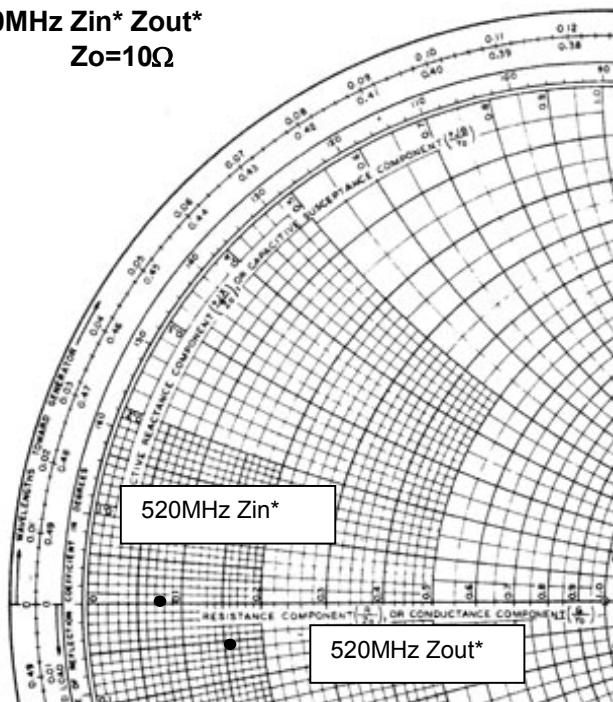


$V_{dd}=7.2V$ ,  $I_{dq}=700mA$ ( $V_{gg}$  adj.),  $P_{in}=0.28W$

$Z_{in}^*=1.55+j5.53$   
 $Z_{out}^*=3.24-j0.26$

$Z_{in}^*$ : Complex conjugate of input impedance  
 $Z_{out}^*$ : Complex conjugate of output impedance

520MHz  $Z_{in}^*$   $Z_{out}^*$   
 $Z_o=10\Omega$



$V_{dd}=7.2V$ ,  $I_{dq}=750mA$ ( $V_{gg}$  adj.),  $P_{in}=0.7W$

$Z_{in}^*=0.76+j0.06$   
 $Z_{out}^*=1.61-j0.52$

$Z_{in}^*$ : Complex conjugate of input impedance  
 $Z_{out}^*$ : Complex conjugate of input impedance

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## RD07MVS1 S-PARAMETER DATA (@Vdd=7.2V, Id=750mA)

Freq. [MHz]	S11		S21		S12		S22	
	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
100	0.890	-174.1	5.508	82.1	0.016	-3.6	0.790	-172.8
150	0.897	-175.6	3.613	75.0	0.015	-8.5	0.801	-174.0
175	0.899	-176.0	3.028	72.4	0.015	-9.6	0.802	-174.1
200	0.901	-176.3	2.604	70.1	0.014	-10.9	0.815	-174.0
250	0.907	-176.7	2.019	65.6	0.014	-12.7	0.844	-174.1
300	0.913	-177.0	1.614	60.7	0.012	-15.3	0.843	-174.1
350	0.918	-177.3	1.308	57.1	0.011	-15.8	0.860	-174.4
400	0.924	-177.8	1.102	54.1	0.010	-14.2	0.879	-175.0
450	0.928	-178.0	0.929	50.1	0.009	-14.8	0.882	-175.1
500	0.933	-178.3	0.790	48.6	0.008	-9.6	0.895	-175.5
520	0.935	-178.5	0.753	47.6	0.007	-7.7	0.901	-175.8
550	0.937	-178.8	0.692	45.3	0.007	-5.6	0.906	-176.2
600	0.940	-179.2	0.595	43.6	0.006	0.4	0.907	-176.6
650	0.942	-179.4	0.529	42.4	0.006	17.1	0.916	-177.2
700	0.944	-179.8	0.467	40.2	0.005	21.8	0.923	-177.6
750	0.947	179.8	0.416	39.4	0.005	40.9	0.921	-178.0
800	0.948	179.4	0.374	38.6	0.004	52.0	0.930	-178.8
850	0.949	179.0	0.343	37.6	0.005	67.1	0.933	-178.9
900	0.951	178.6	0.304	36.5	0.005	72.6	0.932	-179.3
950	0.951	178.2	0.284	37.6	0.006	85.8	0.937	179.8
1000	0.952	177.9	0.262	35.1	0.007	85.1	0.938	179.7
1050	0.950	177.4	0.234	36.0	0.008	89.8	0.938	179.3
1100	0.952	176.9	0.226	35.8	0.009	93.4	0.940	178.2



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## ATTENTION:

1. High Temperature ; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
2. Generation of High Frequency Power ; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
3. Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

## PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
2. RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products , please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of T<sub>chmax</sub>=150deg/C) , 140deg/C(in case of T<sub>chmax</sub>=175deg/C) under standard conditions.
6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.
10. Please refer to the additional precautions in the formal specification sheet.

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Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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